

# PATENT ASSIGNMENT

Electronic Version v1.1

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Heida L. Thurlow	07/14/2011
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Lentrade, Inc.
<b>Street Address:</b>	5425 North Sam Houston Parkway West
<b>City:</b>	Houston
<b>State/Country:</b>	TEXAS
<b>Postal Code:</b>	77086
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	29392336
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(832)678-2354
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
<b>Phone:</b>	832-678-2349
<b>Email:</b>	DOCKETING@PATENT-LAW.CC
<b>Correspondent Name:</b>	STREETS & STEELE
<b>Address Line 1:</b>	13100 WORTHAM CENTER DRIVE, SUITE 245
<b>Address Line 4:</b>	HOUSTON, TEXAS 77065
<b>ATTORNEY DOCKET NUMBER:</b>	CHAN/0076
<b>NAME OF SUBMITTER:</b>	Patrick K. Steele
<b>Total Attachments: 2</b> source=CHAN0076_Assignment#page1.tif source=CHAN0076_Assignment#page2.tif	

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**PATENT**  
**REEL: 026592 FRAME: 0991**

## ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Name and Address of Inventor:

- 1) Heida L. Thurlow  
4 Woodstone Street  
Houston, Texas 77024

(hereinafter referred to as Assignor), has invented a certain invention entitled:

### "PIE PLATE"

for which application for Letters Patent in the United States has been prepared, and that said Assignor hereby authorize and request an attorney of the Streets & Steele firm, of 13100 Wortham Center Dr., Suite 245, Houston, Texas, 77065, to insert here in parentheses (application number 29/392,336, filed May 19, 2011) the filing date and application number of said application when known; and

WHEREAS, Lentrade, Inc., a corporation of the State of Texas, having a place of business at 5425 North Sam Houston Parkway West, Houston, Texas 77086 (hereinafter referred to as Assignee), desires to acquire the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignor, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignor to have been received in full from said Assignee:

1. Said Assignor hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest in and to
  - (a) said Application and said Invention;
  - (b) all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise;
  - (c) any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and
  - (d) each and every reissue or extension of any of said Patents.

2. Said Assignor hereby covenants and agrees to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignor shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee for:

- (a) for perfecting in said Assignee the right, title and interest herein conveyed;
- (b) for prosecuting any of said applications;
- (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention;
- (d) for filing and prosecuting applications for reissuance of any of said Patents;
- (e) for interference or other priority proceedings involving said Invention; and
- (f) for legal proceedings involving said Invention and any application therefore and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions;

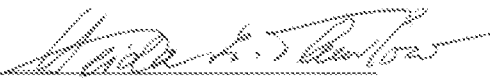
provided, however, that the expense incurred by said Assignor in providing such cooperation shall be paid for by said Assignee.

3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignor, her respective heirs, legal representatives and assigns.

4. Said Assignor hereby warrants and represents that she has not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignor have executed and delivered this instrument to said Assignee on the dates indicated below.

1) \_\_\_\_\_, 2011

  
Heida L. Thurlow